

“EDL provides technologies and engineering to configure systems that meet special and often unique customer requirements. We listen, study, design, and deliver value.”

PACK EXPO 2008

It's that time of year again! This year EDL will be in Booth S-2278 with three of our innovative systems that are designed to save time, money, improve quality, and productivity.

Please contact your Area Sales Manager and let them know who from your company will be at the show, and what prospects you will be bringing to the EDL Booth.

This year we will be displaying our:

- Panel Pack System –this system is specifically designed for panel-shaped products in a make - to-order environment. The System featured in Chicago can wrap a wide variety of products – windows, office partitions, fence panels, furniture, and any other type of flat product. Sizes can range from 12” to 72” in width and 15” to 108” in length and be fed at random with no set up or changeover required!



- Double Tight Wrap (DTW) System - EDL's signature Double Tight Wrap technology will be on display in Chicago. The DTW system will be configured for bundling bagged products such as Sugar, Flour, Rice, or Cat Litter. This type of wrapper can also be built to accommodate a wide variety of different primary package types including cartons, jugs and flexible containers.



- Mono Block Semi-Automatic Bundling System - from our Standard Integrated Engineered System Range, this simple, cost-effective, and flexible system is ideally configured for contract packagers, low-volume manufactures, and others that seek flexibility and low capital cost.



Why EDL?

EDL has over 40 years of experience designing and manufacturing shrink bundling machinery. The expertise gained and the technology developed over the years has helped us become an industry leader in innovative packaging solutions.

Bring us your application and let us apply our Innovative Solutions! Remember we listen, study, design, and deliver value to our customers!

The video for these systems mentioned above and many others can be viewed via the "Login" section of the EDL website: www.edlpackaging.com. Login is: [edlpackaging](#) and the password is: [clients](#). Please contact your EDL Area Sales Manager for further information.

PACK EXPO INTERNATIONAL – CHICAGO, IL 2008

EDL Packaging Engineers, Inc.

Invites you to visit us at **PACK EXPO** International / Process Expo / CPP EXPO 2008
McCormick Place, Chicago, IL USA
November 9-13, 2008
Booth: S-2278

For your FREE registration:

- Go to www.packexpo.com and click on "Register Now".
- Proceed with Registration.
- In "Registration Type" Section: enter the following code in the box provided: **54W89**
- Your registration fee will be waived prior to your checkout.

OFFER VALID FOR ON-LINE PRE-REGISTRATION ONLY. EXPIRES 11/5/08. NOT VALID ON SITE. NO CASH VALUE.

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